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| U.S. Department of Commerce, Patent and Trademark Office | | | | | Atty. Docket No. | | Serial No. | |
| | | | | | M-7528 US | | 30-47604 | |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT | | | | | Applicant(s) | | | |
| (Use several sheets if necessary) | | | | | Zhang, Fan,;; Towery, Daniel L. | | | |
| | | | | | Filing Date | | Group | |
| | | | | | Herewith | | Unknown | |



07/19/99

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| | AK | | | | | | |

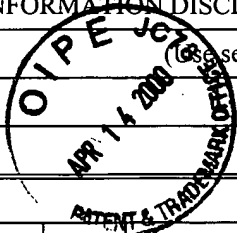
| Foreign Patent Documents | | | | | | | | |
|--------------------------|----|----------|------|---------|-------|----------|-------------|----|
| | | | | | | | Translation | |
| | | Document | Date | Country | Class | Subclass | Yes | No |
| | AL | | | | | | | |
| | AM | | | | | | | |

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| CB | AN | Maria Georgiadou and Richard Alkire, "Anisotropic Chemical Etching of Copper Foil" I. Electrochemical Studies in Acidic CuCs ₂ Solutions, J. Electrochem Soc., Vol. 140, No. 5, May 1993, pp. 1340-1347 including front page and index. |
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| Examiner <i>Charles Burn</i> | Date Considered <i>11/21/99</i> |
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.

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| U.S. Department of Commerce, Patent and Trademark Office | | | | | | Atty Docket No. | | Serial No. | |
| | | | | | | M-7528 US | | 09/357,264 | |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT | | | | | | Applicant | | | |
| (Use several sheets if necessary) | | | | | | Fan Zhang et al. | | | |
| | | | | | | Filing Date | | Group | |
| | | | | | | July 19, 1999 | | 3723 | |
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| | | | | | | | Translation | | |
| | | Document | Date | Country | Class | Subclass | Yes | No | |
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| | AQ | | | | | | | | |
| | AR | | | | | | | | |
| | AS | | | | | | | | |
| Examiner | | Charlotte C. Baum | | | | | | | |
| Date Considered | | 11-21-00 | | | | | | | |
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